# Vishay Siliconix

# N-Channel 100 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	100					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.023					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.024					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.031					
Q <sub>g</sub> typ. (nC)	9.7					
I <sub>D</sub> (A) <sup>a</sup>	11.1					
Configuration	Single					

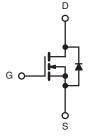
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



#### **APPLICATIONS**

- DC/DC primary side switch
- Telecom / server
- Industrial
- Synchronous rectification



N-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4056DY-T1-GE3			

PARAMETER Drain-source voltage Gate-source voltage		SYMBOL V <sub>DS</sub>	LIMIT	V
			100	
		V <sub>GS</sub>	± 20	
	T <sub>C</sub> = 25 °C		11.1	
Continuous dusin suurent (T. 150 °C)	T <sub>C</sub> = 70 °C		8.8	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	7.3 b, c	
	T <sub>A</sub> = 70 °C		5.8 <sup>b, c</sup>	^
Pulsed drain current (t = 300 µs)		I <sub>DM</sub>	70	Α
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		5.1	
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.2 <sup>b, c</sup>	
Single pulse avalanche current		I <sub>AS</sub>	15	
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	11.2	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C		5.7	
	T <sub>C</sub> = 70 °C		3.6	147
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	35	50	°C/W		
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	18	22	7 C/W		

#### Notes

- a. Based on  $T_C = 25$  °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}$

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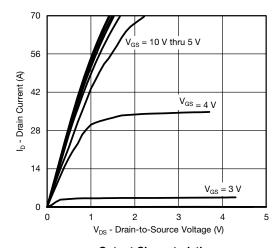
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 ·· A	-	67	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \ \mu A$	1.5	-	2.8	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zoro gata valtaga drain aurrent		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V	-	-	1	μА	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.017	0.023		
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 12 A	-	0.018	0.024	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.022	0.031		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	-	26	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	900	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	340	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	31	-		
Total gate charge	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	19.6	29.5	-	
			-	9.7	15		
Gate-source charge	Q <sub>qs</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	2.8	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	4.3	-	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$	-	26.2	40		
Gate resistance	$R_{g}$	f = 1 MHz	0.2	0.85	1.7	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	13	26		
Rise time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_1 = 5 \Omega$	-	14	28		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$	-	19	38		
Fall time	t <sub>f</sub>		-	10	20		
Turn-on delay time	t <sub>d(on)</sub>		-	11	22	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_1 = 5 \Omega$	-	10	20	- - -	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	20	40		
Fall time	t <sub>f</sub>		-	9	18		
Drain-Source Body Diode Characterist	ics		•				
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	<u> </u>	_	5.1		
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>	-	-	-	70	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 4 A	-	0.77	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	<u> </u>	_	34	65	ns	
undad to			_	34		nC	
Body diode reverse recovery charge	(.)		_		nn:		
Body diode reverse recovery charge Reverse recovery fall time	Q <sub>rr</sub>	$I_F = 5 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$ $T_J = 25 \text{ °C}$		20	65 -	IIC	

#### Notes

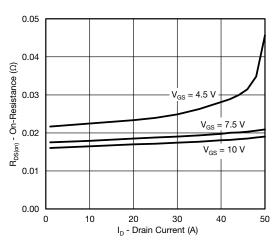
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

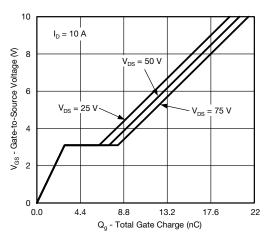




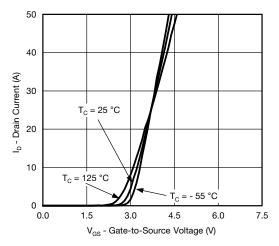
### **Output Characteristics**



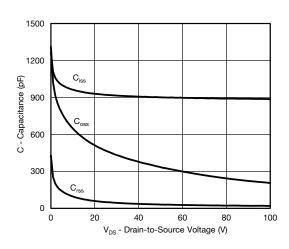
On-Resistance vs. Drain Current



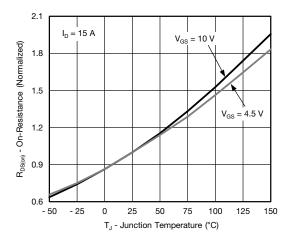
**Gate Charge** 



**Transfer Characteristics** 

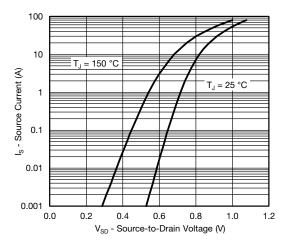


Capacitance

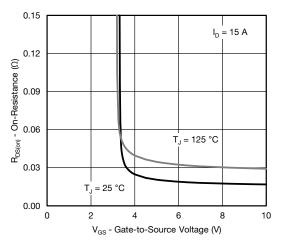


On-Resistance vs. Junction Temperature

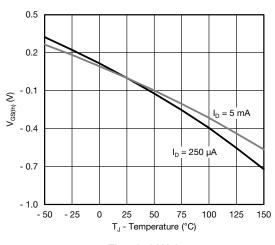




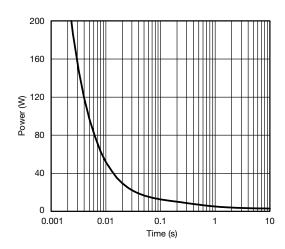
Source-Drain Diode Forward Voltage



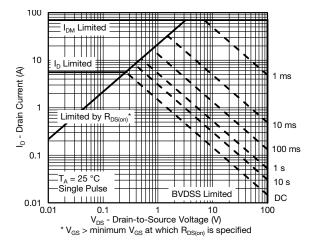
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

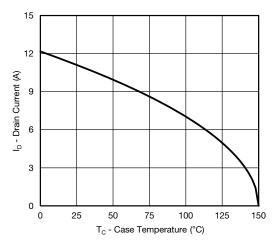


Single Pulse Power, Junction-to-Ambient

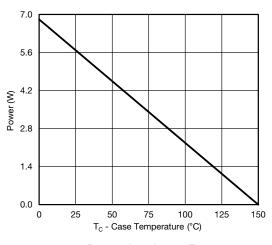


Safe Operating Area, Junction-to-Ambient

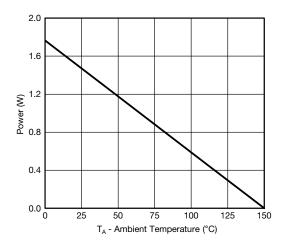




#### Current Derating a





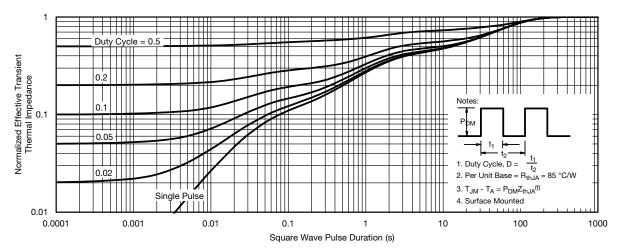


Power, Junction-to-Ambient

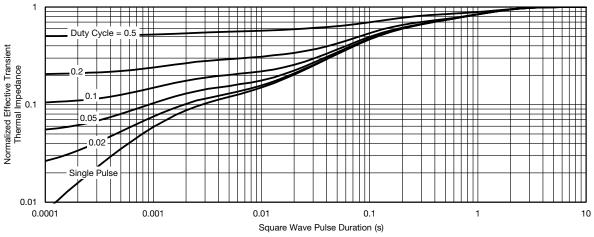
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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